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Total No. of Printed Pages: 1

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**B. Tech. (ECE) (Semester – 3<sup>rd</sup>)**  
**ELECTRONIC DEVICES & CIRCUITS**  
**Subject Code: BECES1301**  
**Paper ID: [18111310]**

**Time: 03 Hours**

**Maximum Marks: 60**

**Instruction for candidates:**

1. Section A is compulsory. It consists of 10 parts of two marks each.
2. Section B consist of 5 questions of 5 marks each. The student has to attempt any 4 questions out of it.
3. Section C consist of 3 questions of 10 marks each. The student has to attempt any 2 questions.

**Section – A**

**(2 marks each)**

Q1. Attempt the following:

- a) Differentiate between intrinsic and extrinsic semiconductors.
- b) What are the key properties of a diode?
- c) How do you distinguish between emitter, collector, and base in BJTs.
- d) Draw constructional diagram of JFET.
- e) What is the effect of minority carriers in characteristic curves of a diode?
- f) What is photolithography?
- g) What is Ebers-Moll Model?
- h) What is Schottky diode? List its applications.
- i) Differentiate avalanche and zener breakdowns.
- j) How can we use BJT as a switch?

**Section – B**

**(5 marks each)**

- Q2. Compare BJT and FET in terms of construction, properties and working.
- Q3. Draw constructional diagram of enhancement mode n-MOSFET. Discuss its working with suitable characteristic curves.
- Q4. Discuss small signal low frequency analysis of CE BJT amplifier using h-parameters.
- Q5. Draw CMOS inverter circuit and explain its working.
- Q6. What are various biasing techniques used for BJTs? Compare their stabilities.

**Section – C**

**(10 marks each)**

- Q7. What are high-frequency equivalent models of BJT? Discuss in terms of h-parameters.
- Q8. Discuss various processes involved in integrated circuits fabrication with suitable diagrams.
- Q9. Write short notes on:
  - (a) C-V characteristics of n-MOSFET
  - (b) Twin-tun CMOS process